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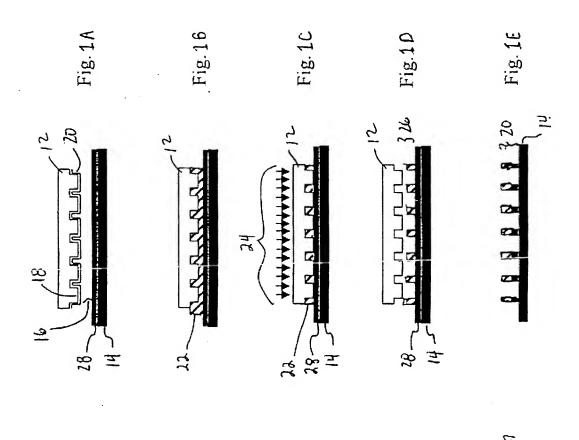
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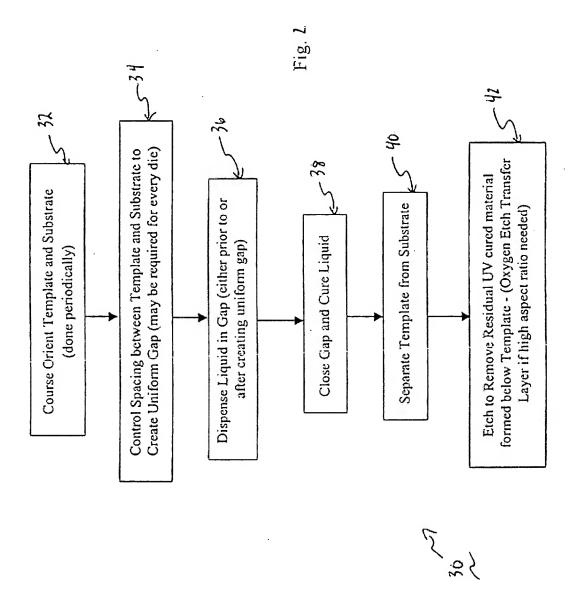
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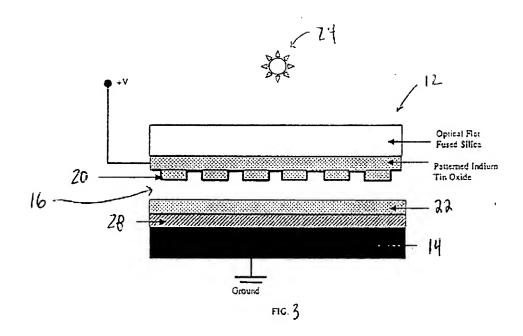
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- Apply electric field and maintain uniform gap to induce the liquid to adhere to the template
- UV cure the liquid
- Separate the template from the substrate.
- Etch to break-through UV cured liquid, followed by RIE etch transfer into transfer layer to obtain high-aspect ratio structure

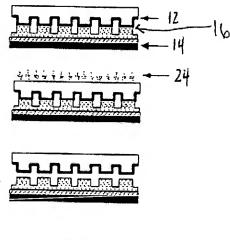
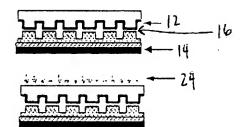


FIG. 4

 Apply electric field and maintain uniform gap to induce the liquid to be attracted to the template without making contact



- UV cure the liquid
- Etch to break-through UV cured liquid, followed by RIE etch transfer into transfer layer to obtain high-aspect ratio structure



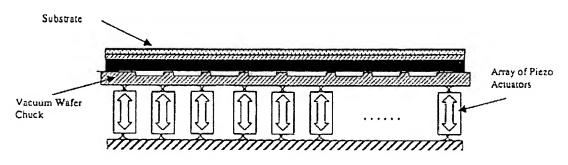


FIG. b

